

3Gbps Video SFP Optical Receiver, PIN photodetector GHR-3G-xxxD

Features

- ✓ HD-SDI SFP Receiver available
- ✓ SD-SDI SFP Receiver available
- ✓ 3G-SDI SFP Receiver available
- ✓ SMPTE 297-2006 Compatible
- ✓ Metal enclosure for Lower EMI
- ✓ PIN photodetector
- ✓ Supports video pathological patterns for SD-SDI, HD-SDI and 3G-SDI
- ✓ SFP Non-MSA Pin out
- ✓ Digital Diagnostic functions available through the I2C interface
- ✓ Compatible with RoHS
- ✓ +3.3V single power supply
- ✓ Operating case temperature range: 0 to +70°C
- ✓ RoHS 2.0 compliant (lead free)



Applications

- ✓ SMPTE 297-2006 Compatible Electrical-to-Optical Interfaces
- ✓ HDTV/SDTV Service Interfaces

Description

The video series transceivers are high performance, cost effective modules for duplex video transmission application over single mode fiber.

The receiver is designed to receive data rates from 50Mbps to 2.97Gbps and is specifically designed for robust performance in the presence of SDI pathological patterns for SMPTE 259M, SMPTE 344M, SMPTE 292M and SMPTE 424M serial rates. The module is fully compliant with SMPTE 297M-2006.

The receiver consists of a PIN photodiode integrated with a trans-impedance preamplifier (TIA) and MCU control unit. All modules satisfy class I laser safety requirements.

The receivers are compatible with SFP Multi-Source Agreement (MSA) and SFF-8472. For further information, please refer to SFP MSA.

Absolute Maximum Ratings

Parameter	Symbol	Min	Max	Unit
Supply Voltage	V_{cc}	-0.5	4.5	V
Storage Temperature	T_s	-40	85	°C
Operating Humidity	Rh	5	85	%

Recommended Operating Conditions

Parameter	Symbol	Min	Typical	Max	Unit
Operating Case Temperature	T_c	0		70	°C
Power Supply Voltage	V_{cc}	3.13	3.3	3.47	V
Power Supply Current	I_{cc}			150	mA
Data Rate			3		Gbps

Optical and Electrical Characteristics

Parameter		Symbol	Min	Typical	Max	Unit	Notes
Receiver							
Rise/Fall Time (20%~80%)	SD-SDI	tr/tf			270	ps	1
	HD-SDI				270	ps	
	3G-SDI				270	ps	
Total Output Jitter	PRBS and colour bar	SD-SDI		70	200	ps	
		HD-SDI		50	130		
		3G-SDI		70	100		
	pathological	SD-SDI		200	300		
		HD-SDI		115			
		3G-SDI		120			
Centre Wavelength		λ_c	1260		1580	nm	
Receiver Sensitivity (PRBS)	SD-SDI				-22	dBm	
	HD-SDI				-22	dBm	
	3G-SDI				-22	dBm	
Receiver Sensitivity (Pathological)	SD-SDI				-16	dBm	
	HD-SDI				-16	dBm	
	3G-SDI				-15	dBm	
Receiver Overload			0			dBm	3
LOS De-Assert		LOS_D			-22		
LOS Assert		LOS_A	-29				
LOS Hysteresis			1		4	dB	
Data Output Swing Differential		V_{out}	650	800	1000	mV	2

LOS	High	2.0		Vcc	V	
	Low			0.8	V	

Note:

1. Rise and fall times, 20% to 80%, are measured following a fourth-order Bessel-Thompson filter with a bandwidth of 0.75 x clock frequency corresponding to the serial data rate.
2. PECL input, internally AC-coupled and terminated.
3. Internally AC-coupled.

Timing and Electrical

Parameter	Symbol	Min	Max	Unit
LOS Assert Time	t_loss_on		100	μs
LOS De-assert Time	t_loss_off		100	μs
Serial ID Clock Rate	f_serial_clock		280	KHz
MOD_DEF (0:2)-High	V _H	2	Vcc	V
MOD_DEF (0:2)-Low	V _L		0.8	V

Diagnostics Specification

Parameter	Range	Unit	Accuracy	Calibration
Temperature	0 to +70	°C	±3°C	Internal / External
Voltage	3.0 to 3.6	V	±3%	Internal / External
RX Power	-20 to -6	dBm	±3dB	Internal / External

I2C Bus Interface

The I2C bus interface uses the 2-wire serial CMOS E2PROM protocol. The serial interface meets the following specifications:

1. Support a maximum clock rate of 280Khz.
2. Input/Output levels comply with LVCMOS/LVTTL or compatible logics.

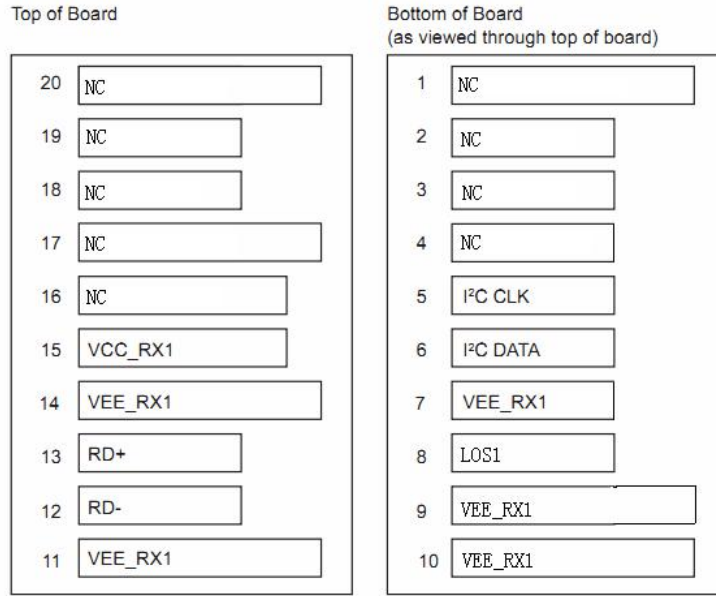
Low: 0- 0.8 V

High: 2.0 -3.3 V

Undefined: 0.8 -2.0 V

Pin Description(Non-MSA)

Pin Diagram



Pin Descriptions

Pin	Symbol	Name/Description	Plug Seq.	Notes
1	NC	Not Connected	1	
2	NC	Not Connected	3	
3	NC	Not Connected	3	
4	NC	Not Connected	3	
5	I2C CLK	SCL Serial Clock Signal	3	Note 1
6	I2C DATA	SDA Serial Data Signal	3	Note 1
7	VEE_RX1	Receiver1 Ground	3	
8	LOS1	Loss of Signal	3	Note 2
9	VEE_RX1	Receiver1 Ground	1	
10	VEE_RX1	Receiver1 ground	1	
11	VEE_RX1	Receiver1 ground	1	
12	RD-	Inv. Received Data Out	3	Note 3
13	RD+	Received Data Out	3	Note 3
14	VEE_RX1	Receiver1 ground	1	
15	VCC_RX1	Receiver1 Power Supply	2	
16	NC	Not Connected	2	
17	NC	Not Connected	1	
18	NC	Loss of Signal	3	
19	NC	Not Connected	3	
20	NC	Not Connected	1	

Note:

Plug Seq.: Pin engagement sequence during hot plugging.

1) These are the module definition pins. They should be pulled up with a 4.7k~10kΩ resistor on the host board.

The pull-up voltage shall be VccR.

I2C CLK is the clock line of two wire serial interface for serial ID

I2C DATA is the data line of two wire serial interface for serial ID

- 2) LOS is an open collector output, which should be pulled up with a 4.7k~10kΩ resistor. Pull up voltage between 2.0V and Vcc+0.3V. Logic 1 indicates loss of signal; Logic 0 indicates normal operation. In the low state, the output will be pulled to less than 0.8V.
- 3) RD-/+ : These are the differential receiver outputs. They are internally AC-coupled 100 differential lines which should be terminated with 100Ω (differential) at the user SERDES.

Serial ID Field Memory Map

The module serial Id and calibration information is stored in the E2PROM of the SFP supervising device using the address map.

Byte Addr	Bit Size	Name	Description	Value (hex)
0	1	Identifier	Type of transceiver	82
1	1	Ext. Identifier	Extended identifier of type of transceiver	04
2	1	Connector	Code for connector type	07
3	1	Standards Compliance	For SMPTE259M/344M/292M/424M and SMPTE 297M	41
4	7	Transceiver	Code for electronic or optical compatibility, Not applicable.	
5				
6				
7				
8				
9				
10				
11	1	Encoding	Code for serial encoding algorithm	30
12	1	BR, Nominal	Nominal signalling rate, units of 100MBd.	1E
13	1	Rate Identifier	Type of rate select functionality, Not applicable	
14	1	Length(SMF,km)	Link length supported for single mode fiber, units of km	14
15	1	Length (SMF)	Link length supported for single mode fiber, units of 100 m	00
16	1	Length (50um)	Link length supported for 50 um OM2 fiber, units of 10 m	00
17	1	Length (62.5um)	Link length supported for 62.5 um OM1 fiber, units of 10 m	00
18	1	Length (cable)	Link length supported for copper or direct attach cable, units of m	00

19	1	Length (OM3)	Link length supported for 50 um OM3 fiber, units of 10 m	00
20	16	Vendor name	SFP vendor name (ASCII)	X
21				X
22				X
23				X
24				X
25				X
26				X
27				X
28				X
29				X
30				X
31				X
32				X
33				X
34				X
35				X
36	1	Reserved	Reserved	00
37	3	Vendor OUI	SFP vendor IEEE company ID	00
38				00
39	16	Vendor PN	Part number provided by SFP vendor (ASCII)	00
40				X
41				X
42				X
43				X
44				X
45				X
46				X
47				X
48				X
49				X
50				X
51				X
52				X
53				X
54				X
55	4	Vendor rev	Revision level for part number provided by vendor (ASCII)	X
56				X
57				X
58				X
59	2	Wavelength	Laser wavelength (Passive/Active Cable Specification Compliance)	X
60				X
61	1	Unallocated		X
62				X

63	1	CC_BASE	Check code for Base ID Fields	
64	2	Options	Indicates which optional transceiver signals are implemented	
65				
66	1	BR, max	Upper bit rate margin, units of %	05
67	1	BR, min	Lower bit rate margin, units of %	5F
68	16	Vendor SN	Serial number provided by vendor (ASCII)	X
69				X
70				X
71				X
72				X
73				X
74				X
75				X
76				X
77				X
78				X
79				X
80				X
81				X
82				X
83				X
84	8	Date code	Vendor's manufacturing date code	
85				
86				
87				
88				
89				
90				
91				
92	1	Diagnostic Monitoring Type	Indicates which type of diagnostic monitoring is implemented(if any) in the transceiver	28
93	1	Enhanced Options	Indicates which optional enhanced features are implemented(if any) in the transceiver	90
94	1	SFF-8472Compliance	Indicates which revision of SFF-8472 the transceiver complies with.	X
95	1	CC_EXT	Check code for the Extended ID Fields	
96	32	Vendor Specific	Vendor Specific EEPROM	0
97				0
98				0
99				0
100				0
101				0
102				0
103				0
104				0

105				0
106				0
107				0
108				0
109				0
110				0
111				0
112				0
113				0
114				0
115				0
116				0
117				0
118				0
119				0
120				0
121				0
122				0
123				0
124				0
125				0
126				0
127				0

Digital Diagnostic Monitoring Interface (2-Wire Address A2H)

Byte Addr	Bit Size	Name	Description and Value of the Field
00-01	2	Temp High Alarm	MSB at lower address. 100°C
02-03	2	Temp Low Alarm	MSB at lower address. -50°C
04-05	2	Temp High Warning	MSB at lower address. 95°C
06-07	2	Temp Low Warning	MSB at lower address. -45°C
08-09	2	Voltage High Alarm	MSB at lower address. 3.7V
10-11	2	Voltage Low Alarm	MSB at lower address. 2.9V
12-13	2	Voltage High Warning	MSB at lower address. 3.6V
14-15	2	Voltage Low Warning	MSB at lower address. 3.0V
16-17	2	Bias High Alarm	MSB at lower address. 70mA
18-19	2	Bias Low Alarm	MSB at lower address. 8mA
20-21	2	Bias High Warning	MSB at lower address. 65mA
22-23	2	Bias Low Warning	MSB at lower address. 9mA
24-25	2		
26-27	2		
28-29	2		
30-31	2		

32-33	2	RX Power High Alarm	MSB at lower address. 1dBm
34-35	2	RX Power Low Alarm	MSB at lower address. -25dBm
36-37	2	RX Power High Warning	MSB at lower address. 0dBm
38-39	2	RX Power Low Warning	MSB at lower address. -24dBm
40-55	16	Reserved	Reserved
56-59	4		
60-63	4		
64-67	4		
68-71	4		
72-75	4		
76-77	2	TX_I (Slope)	Set to 1 for “internally calibrated” devices. Value is 01 00.
78-79	2	TX_I (Offset)	Set to zero for “internally calibrated” devices. Value is 00 00.
80-81	2	TX_PWR (Slope)	Set to 1 for “internally calibrated” devices. Value is 01 00.
82-83	2	TX_PWR (Offset)	Set to zero for “internally calibrated” devices. Value is 00 00.
84-85	2	T (Slope)	Set to 1 for “internally calibrated” devices. Value is 01 00.
86-87	2	T (Offset)	Set to zero for “internally calibrated” devices. Value is 00 00.
88-89	2	V (Slope)	Set to 1 for “internally calibrated” devices. Value is 01 00.
90-91	2	V (Offset)	Set to zero for “internally calibrated” devices. Value is 00 00.
92-94	3	Reserved	Reserved
95	1	Checksum	Checksum of bytes 0 – 94.
96-97	2	Temperature (MSB, LSB)	Internally measured module temperature
98-99	2	Supply Voltage (MSB, LSB)	Internally measured supply voltage in module
100-101	2	Bias1()(MSB, LSB)	Internally measured module bias1
102-103	2	Tx1 Power(MSB, LSB)	Internally measured Tx1 Power Current
104-105	2	Tx2 Power (MSB, LSB)	Internally Measured Tx2 Power Current
106-107	2	Bias2()(MSB, LSB)	Internally measured module bias2
108-109	2	Reserved	Reserved
110	Bit7	Tx Disable State	Digital state of the TX Disable Input Pin.
110	Bit6	Soft Tx Disable	Bit 6
110	Bit5-Bit3	Reserved	
110	Bit2	Tx Fault	Bit 2
110	Bit1		Bit1
110	Bit0	Data_Ready	Bit 0
111	1	Reserved	Reserved
112	1		

113	1		
114-115	Reserved		Reserved
116	1		
117	1		
118-119	2	Reserved	Reserved
120-127	8	Vendor specific	
128-247	120	User EEPROM	User writable EEPROM
248-255	8	Vendor Specific	Vendor specific control functions

Mechanical Dimensions

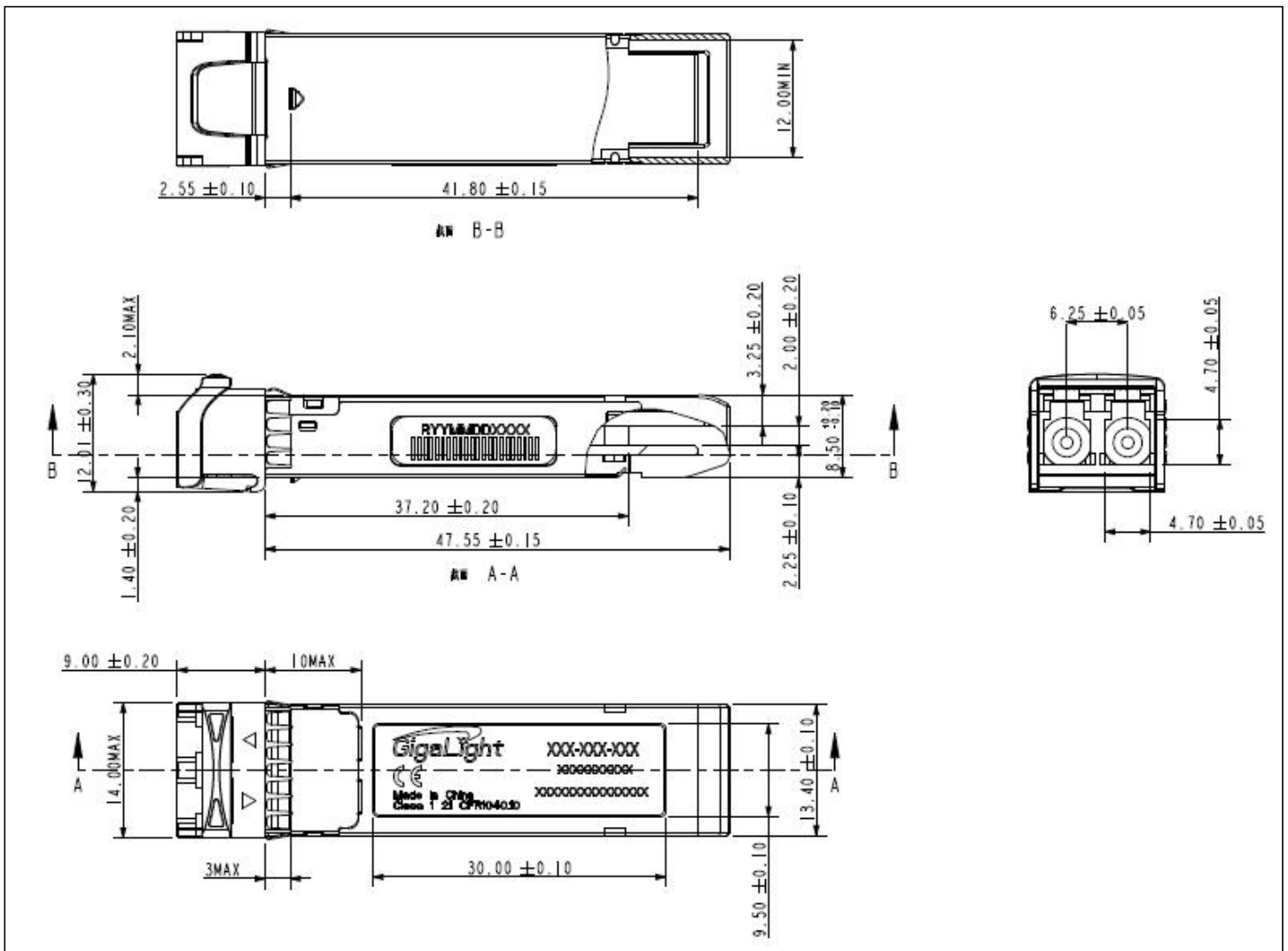


Figure1 . Mechanical Specifications

Regulatory Compliance

Gigalight GHR-3G-XXCD 3G VIDEO transceivers are Class 1 Laser Products. They are certified per the following standards:

Feature	Agency	Standard
Laser Eye Safety	FDA/CDRH	CDRH 21 CFR 1040 and Laser Notice 50
Laser Eye Safety	TÜV	IEC 60825-1:2014 EN 60825-1:2014 EN 60825-2:2004+A1+A2
Electrical Safety	TÜV	EN 60950-1:2006+A11+A1+A12+A2
Electrical Safety	UL/CSA	UL 60950-1 & CAN/CSA C22.2 No.60950-1 CLASS 3862.07 CLASS 3862.87
EMC	FCC	47 CFR FCC Part 15 Subpart B
EMC	CE-EMC	EN 55032:2015 EN 55024:2010+A1:2015 EN 61000-3-2:2014 EN 61000-3-3:2013

Complies with FDA performance standards for laser products except for deviations pursuant to Laser Notice No. 50, dated June 24, 2007.

References

1. SMPTE 297-2006 Compatible Electrical-to-Optical Interfaces
2. HDTV/SDTV Service Interfaces.
3. Directive 2011/65/EU of the European Parliament and of the Council, “on the restriction of the use of certain hazardous substances in electrical and electronic equipment,” July 1, 2011.

CAUTION:

Use of controls or adjustment or performance of procedures other than those specified herein may result in hazardous radiation exposure.

Ordering Information

Part Number	Product Description
GHR-3G-XXCD	PIN, 3Gbps, 0°C ~ +70°C, With Digital Diagnostic Monitoring, Non-MSA Pinout

Important Notice

Performance figures, data and any illustrative material provided in this data sheet are typical and must be specifically confirmed in writing by Gigalight before they become applicable to any particular order or contract. In accordance with the Gigalight policy of continuous improvement specifications may change without notice.

The publication of information in this data sheet does not imply freedom from patent or other protective rights of Gigalight or others. Further details are available from any Gigalight sales representative.

E-mail: sales@gigalight.com

Official Site: www.gigalight.com

Revision History

Revision	Date	Description
V0	Dec 2017	Advance Release.
V1	Nov-15-2018	Change the Sensitivity: SD-SDI/HD-SDI <-16dBm ; 3G-SDI <-15dBm